L Number	Hits	Search Text	DB	Time stamp
109	2	("6399489").PN.	USPAT;	2003/03/04 08:11
100		,	US-PGPUB;	
			EPO; JPO;	1
			DERWENT;	<u> </u>
			IBM TDB	
110	2	("6084304").PN.	USPAT;	2003/03/04 08:11
110	_	(0001301)	US-PGPUB;	2003,03,01
			EPO; JPO;	
			DERWENT;	
			IBM TDB	1
112	50	(USPAT;	2003/03/04 14:42
112	50	(upper adj metal) with (gold, au)	4	2003/03/04 14:42 ;
			US-PGPUB;	
			EPO; JPO;	
			DERWENT;	
			IBM_TDB	
113	3463	257/758	USPAT;	2003/03/04 08:30
			US-PGPUB;	
			EPO; JPO;	
			DERWENT;	
			IBM_TDB	
125	386	(257/752).CCLS.	USPAT;	2003/03/04 12:43
1			US-PGPUB;	•
			EPO; JPO;	!
			DERWENT;	•
			IBM TDB	1
126	662	257/759	USPAT;	2003/03/04 14:44
120	002	2017103	US-PGPUB;	2003,03,01 11111
			EPO; JPO;	1
			DERWENT;	
		•	l e	!
i l	110	257/50	IBM_TDB	: 2002/02/02 12:21
-	118	257/58	USPAT;	2003/03/03 12:31
			US-PGPUB;	
			EPO; JPO;	
			DERWENT;	
			IBM_TDB	1
-	388	((planar, planariz\$3) with (passivation))	USPAT;	2003/03/03 13:47
		and (bond\$3)	US-PGPUB;	
			EPO; JPO;	
			DERWENT;	
			IBM TDB	
_	490	polyimide near2 passivation	USPAT;	2003/03/03 14:37
		F7	US-PGPUB;	
			EPO; JPO;	
			DERWENT;	!
			IBM TDB	i
_	308	(polyimide adj dielectric) and (gold, au)	USPAT;	2003/03/03 15:44
_	308	(polyimide ad) dielectic; and (gold, au)	1	1 2003/03/03 13.44
			US-PGPUB;	
			EPO; JPO;	!
			DERWENT;	:
			IBM_TDB	
-	198	((planar, planariz\$3) with (dielectric))	USPAT;	2003/03/04 08:09
ļ		with (polyimide)	US-PGPUB;	
		"	EPO; JPO;	
			DERWENT;	
			IBM TDB	
			1 2 2 2 2 2 2 2 2 2 2 2 2 2 2 2 2 2 2 2	